

# UTC UNISONIC TECHNOLOGIES CO., LTD

3N180-E3 **Preliminary** Power MOSFET

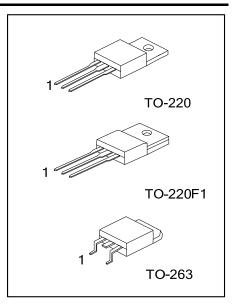
# 3.0A, 1800V N-CHANNEL **POWER MOSFET**

#### **DESCRIPTION**

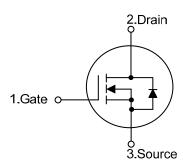
The UTC 3N180-E3 provide excellent RDS(ON), low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

## **FEATURESO**

- \*  $R_{DS(ON)} \le 10.3 \Omega$  @  $V_{GS}=10V$ ,  $I_D=1.5A$
- \* Low Reverse Transfer Capacitance
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, High Ruggedness



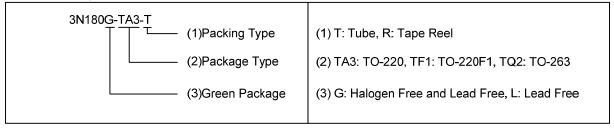
#### **SYMBOL**



# ORDERING INFORMATION

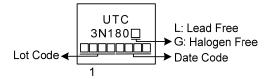
Ordering Number		Dealtage	Pin Assignment			Do akin n	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N180L-TA3-T	3N180G-TA3-T	TO-220	G	D	S	Tube	
3N180L-TF1-T	3N180G-TF1-T	TO-220F1	G	D	S	Tube	
3N180L-TQ2-T	3N180G-TQ2-T	TO-263	G	D	S	Tube	
3N180L-TQ2-R	3N180G-TQ2-R	TO-263	G	D	S	Tape Reel	

Pin Assignment: G: Gate D: Drain S: Source Note:



www.unisonic.com.tw 1 of 7

# ■ MARKING



# ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	1800	V	
Gate-Source Voltage		V <sub>GSS</sub>	±30	V	
Drain Current	Continuous	I <sub>D</sub>	3	Α	
	Pulsed (Note 2)	I <sub>DM</sub>	6	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	133	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6.1	V/ns	
Power Dissipation	TO-220/TO-263	Б	70	W	
	TO-220F1	P <sub>D</sub>	16	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH,  $I_{AS}$  = 2.97A,  $V_{DD}$  = 90V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4. I<sub>SD</sub>  $\leq$  3.0A, di/dt  $\leq$  200A/ $\mu$ s, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C

## **■ THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient		$\theta_{JA}$	62.5	°C/W
Junction to Case	TO-220/TO-263	0	1.78	°C/W
	TO-220F1	θις	7.81	°C/W

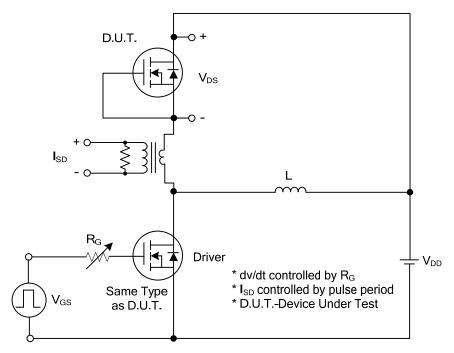
# ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$V_{GS}$ =0 $V$ , $I_D$ =250 $\mu$ A	1800			V		
Drain-Source Leakage Current	$I_{DSS}$	V <sub>DS</sub> =1800V, V <sub>GS</sub> =0V			10	μA		
Gate-Source Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±30V, $V_{DS}$ =0V			±100	nA		
ON CHARACTERISTICS								
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	3.0		5.0	V		
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.5A			10.3	Ω		
DYNAMIC CHARACTERISTICS								
Input Capacitance	C <sub>ISS</sub>			1025		pF		
Output Capacitance	Coss	$V_{DS}$ =25V, $V_{GS}$ =0V, f=1MHz		84		pF		
Reverse Transfer Capacitance	$C_{RSS}$			11		pF		
SWITCHING CHARACTERISTICS								
Total Gate Charge (Note 1)	$Q_{G}$	V <sub>DS</sub> =1440V, V <sub>GS</sub> =10V, I <sub>D</sub> =3.0A (Note 1, 2)		33		nC		
Gate-Source Charge	$Q_GS$			8.6		nC		
Gate-Drain Charge	$Q_GD$			22		nC		
Turn-On Delay Time (Note 1)	$t_{D(ON)}$	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V,		16		ns		
Turn-On Rise Time	t <sub>R</sub>			19		ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	$I_D$ =3.0A, $R_G$ =25 $\Omega$ (Note 1, 2)		95		ns		
Turn-Off Fall Time	t⊧	7		44		ns		
SOURCE- DRAIN DIODE RATINGS AND CHA	ARACTERIST	ics		-				
Maximum Continuous Drain-Source Diode					3	^		
Forward Current	Is				3	Α		
Maximum Pulsed Drain-Source Diode	la				6	Α		
Forward Current	I <sub>SM</sub>				U	A		
Drain-Source Diode Forward Voltage (Note 1)	V <sub>SD</sub>	Is=3.0A, V <sub>GS</sub> =0V			1.4	V		
Body Diode Reverse Recovery Time (Note 1)	t <sub>rr</sub>	I <sub>S</sub> =3.0A, V <sub>GS</sub> =0V,		996		nS		
Body Diode Reverse Recovery Charge	Qrr	dI <sub>F</sub> /dt=100A/μs		8.06		$\mu$ C		

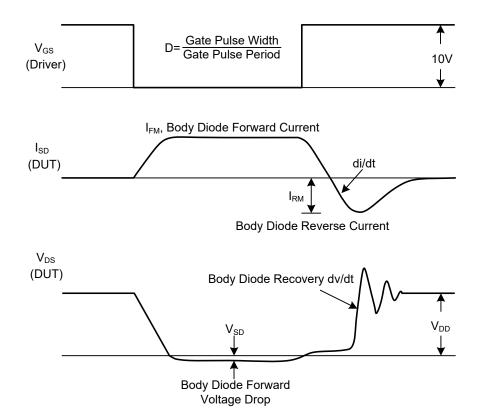
Notes: 1. Pulse Test: Pulse width  $\leq$  300 $\mu$ s, Duty cycle  $\leq$  2%.

<sup>2.</sup> Essentially independent of operating temperature.

## **■ TEST CIRCUITS AND WAVEFORMS**

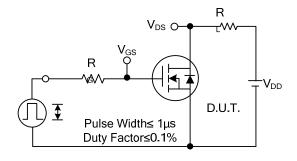


Peak Diode Recovery dv/dt Test Circuit

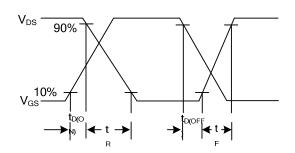


Peak Diode Recovery dv/dt Waveforms

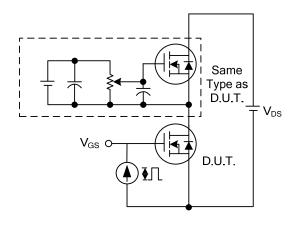
## TEST CIRCUITS AND WAVEFORMS



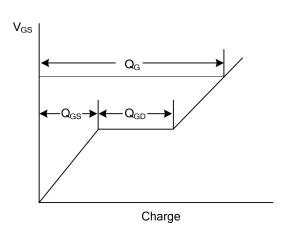
Switching Test Circuit



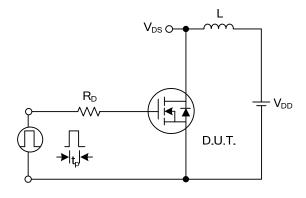
Switching Waveforms



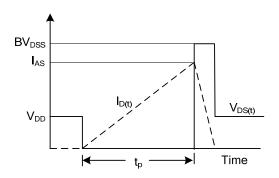
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



**Unclamped Inductive Switching Waveforms** 

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